



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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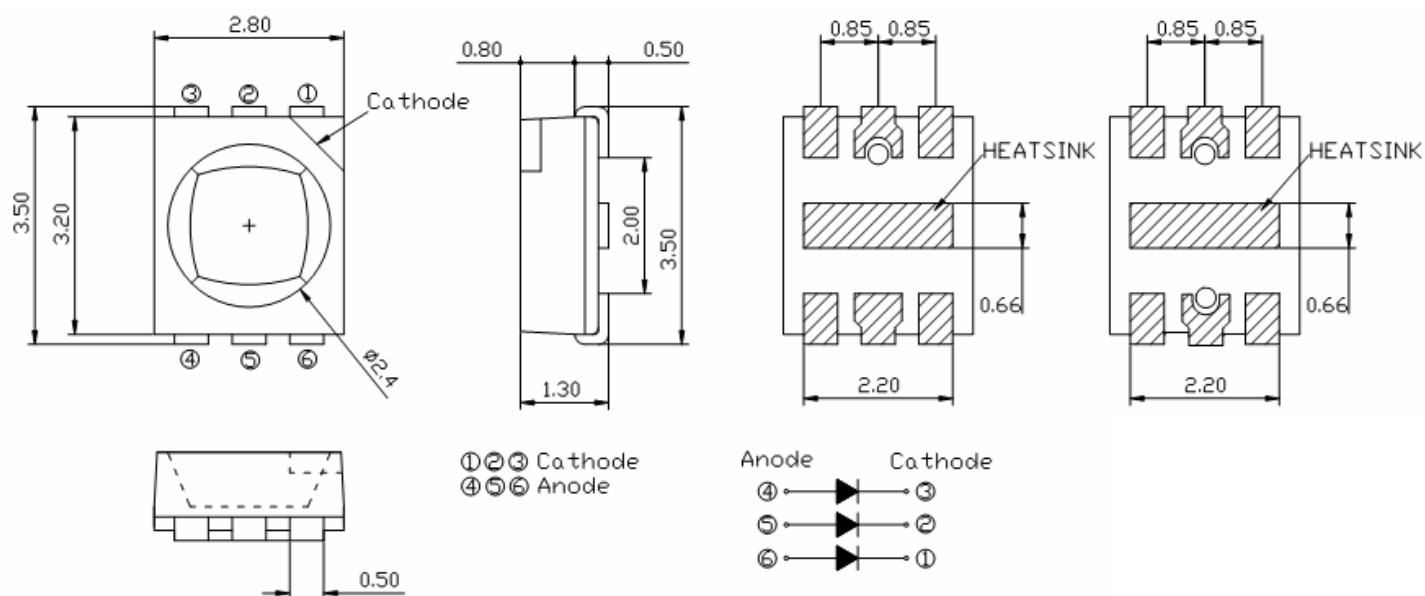


Features

- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic placement equipment.
- * Compatible with infrared and vapor phase reflow solder process.
- * EIA STD package.
- * I.C. compatible.
- * Meet green product and Pb-free(According to RoHS)



Package Dimensions



Part No.	Lens Color	Source Color
LTW-G673VS-CM	Yellow	InGaN Blue

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.2 mm (.008") unless otherwise noted.

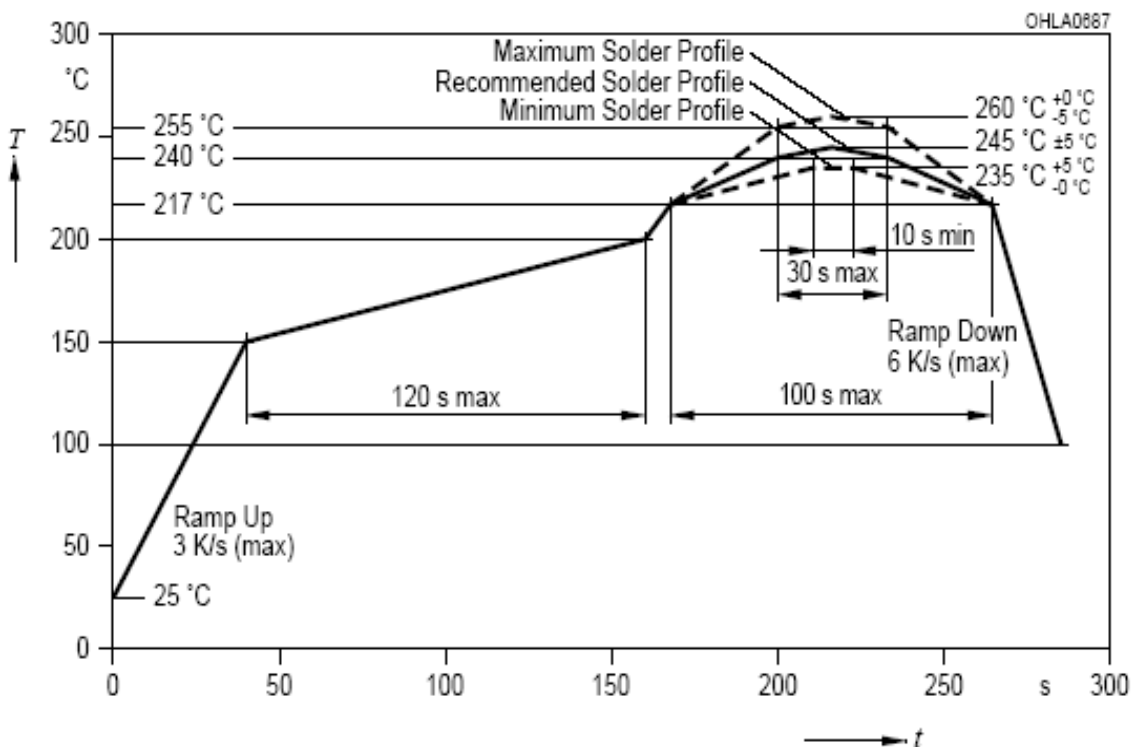
Property of Lite-On Only

Absolute Maximum Ratings at Ta=25°C

Parameter	LTW-G673VS-CM	Unit
Power Dissipation	360	mW
Peak Pulse Current (per die) ($T_w \leq 300\text{ms}$, Duty ratio $\leq 1/10$)	90	mA
DC Forward Current	90	mA
Junction Temperature	100	°C
Thermal Resistance (Junction to Solder)	30	°C/W
Reverse Voltage	5	V
Operating Temperature Range	-30°C to + 85°C	
Storage Temperature Range	-40°C to + 100°C	
Wave Soldering Condition	260°C For 5 Seconds	

Note: Operating the LED (in an application) under reverse bias condition might result in damage or failure of the component.

IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020D)



Property of Lite-On Only

Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTW-	Min.	Typ.	Max.	Unit	Test Condition
Luminous Flux	lm	G673VS-CM	14.5		19	lm	IF = 60mA 20mA / die
Viewing Angle	2 θ 1/2	G673VS-CM		120		deg	Fig.6
Chromaticity Coordinates	x	G673VS-CM		0.280			IF = 60mA 20mA / die Note 3, 5 Fig.1
	y			0.253			
Forward Voltage	VF	G673VS-CM	3.0	3.2	3.4	V	IF = 60mA 20mA / die
Reverse Current (per die)	IR	G673VS-CM			10	μ A	VR = 5V

Note: 1.Luminous flux is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

2. Iv classification code is marked on each packing bag.

3. The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.

4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommended using a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. CAS140B is the test standard for the chromaticity coordinates (x, y) & lm.

6. The Forward Voltage (VF) and Luminous flux (lm) should be added $\pm 0.1V$ & $\pm 10\%$ tolerance.

Property of Lite-On Only

Bin Code List

V _F Spec. Table		
VF Bin	Forward Voltage (V) at I _F = 60mA, 20mA / die	
	Min.	Max.
V1	3.0	3.2
V2	3.2	3.4

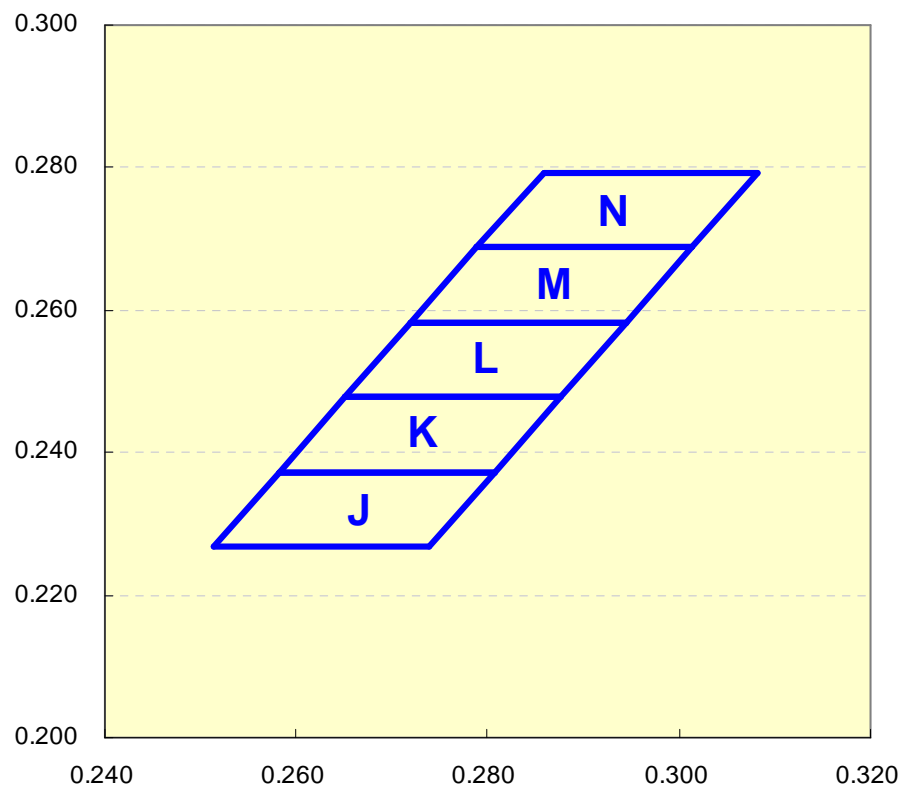
Hint: VF is measured based on independent current source, Vf bin is decided by the average of 3 dices.

Tolerance on each Forward Voltage bin is +/-0.1 volt

Hue Spec. Table					
Hue Bin	Color bin limits at IF = 60mA, 20mA / die				
	CIE 1931 Chromaticity coordinates				
J	x	0.2513	0.2738	0.2807	0.2582
	y	0.2268	0.2268	0.2373	0.2373
K	x	0.2582	0.2807	0.2876	0.2651
	y	0.2373	0.2373	0.2478	0.2478
L	x	0.2651	0.2876	0.2945	0.2720
	y	0.2478	0.2478	0.2583	0.2583
M	x	0.2720	0.2945	0.3014	0.2789
	y	0.2583	0.2583	0.2688	0.2688
N	x	0.2789	0.3014	0.3083	0.2858
	y	0.2688	0.2688	0.2793	0.2793

Tolerance on each Hue (x, y) bin is +/- 0.01

Property of Lite-On Only



Typical Electrical / Optical Characteristics Curves
(25°C Ambient Temperature Unless Otherwise Noted)

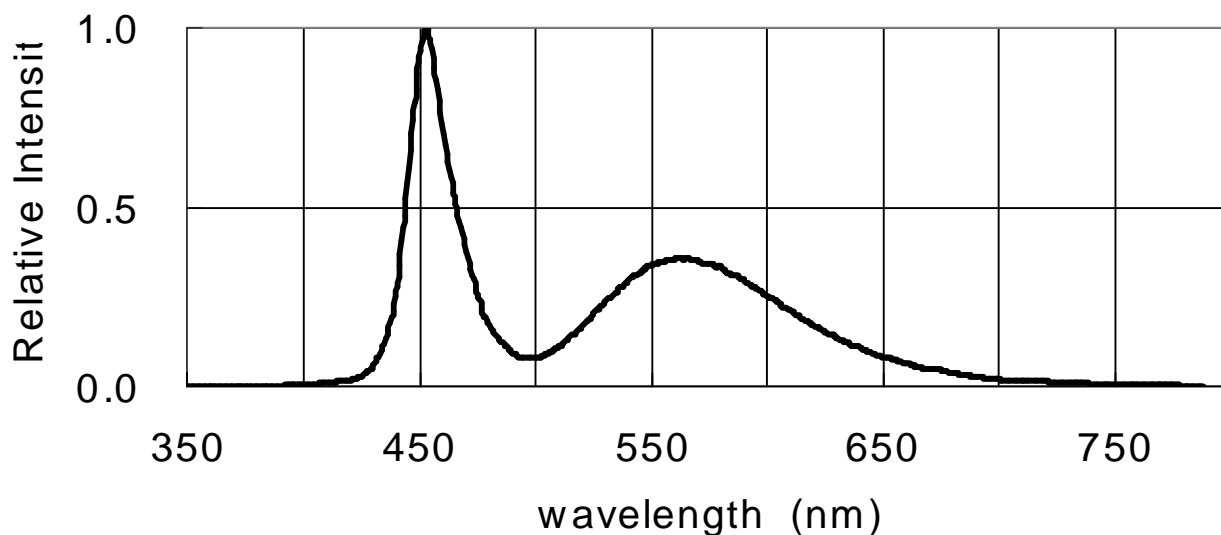


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

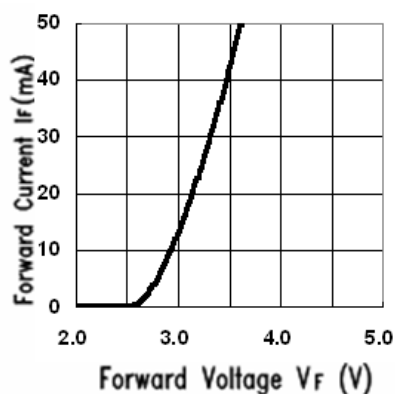


Fig.2 Forward Current vs.
Forward Voltage

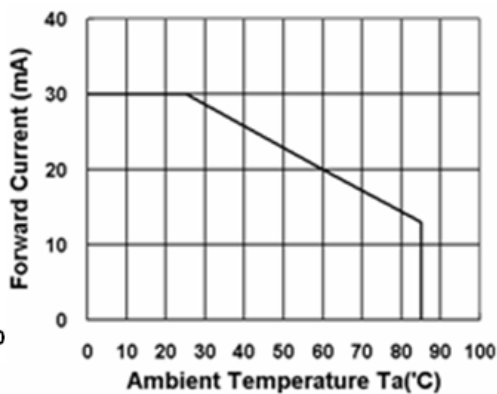


Fig.3 Forward Current
Derating Curve

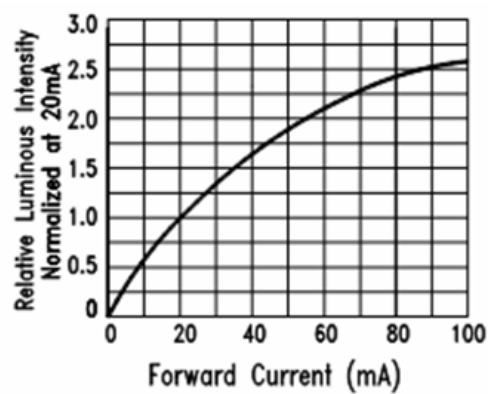


Fig.4 Relative Luminous Intensity
vs. Forward Current

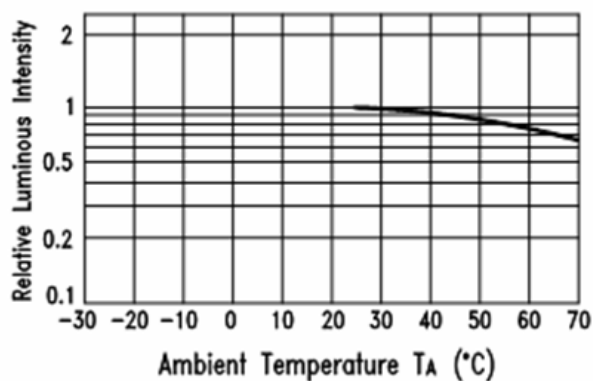


Fig.5 Luminous Intensity vs.
Ambient Temperature

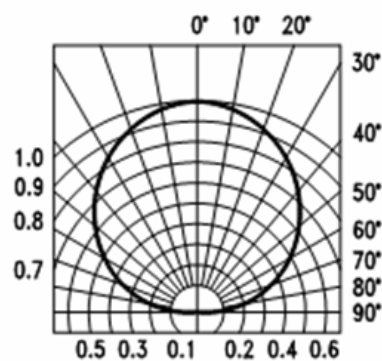


Fig.6 Spatial Distribution

User Guide

Cleaning

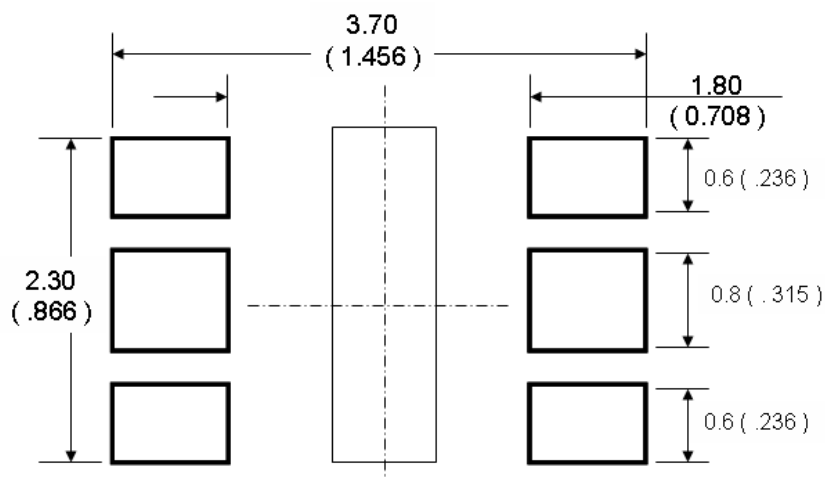
Do not use unspecified chemical liquid to clean LED they could harm the package.

If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less than one minute.

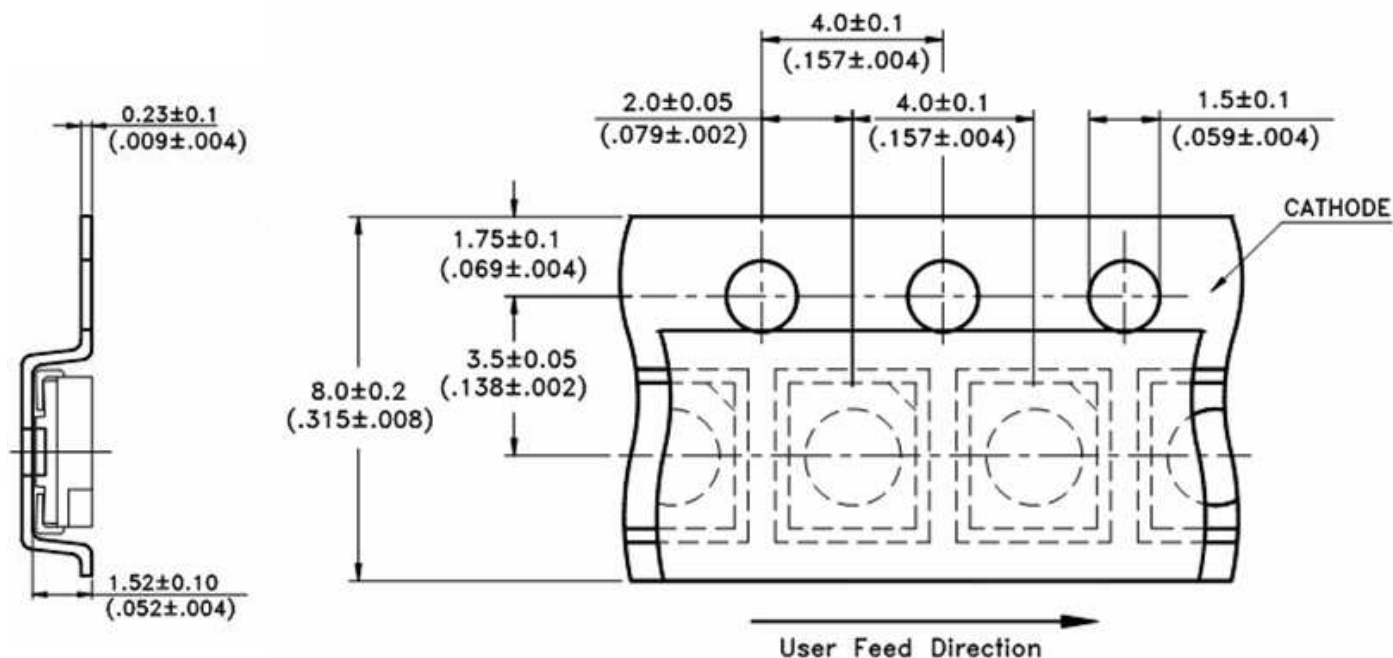
Recommend Printed Circuit Board Attachment Pad

Infrared / vapor phase

Reflow Soldering



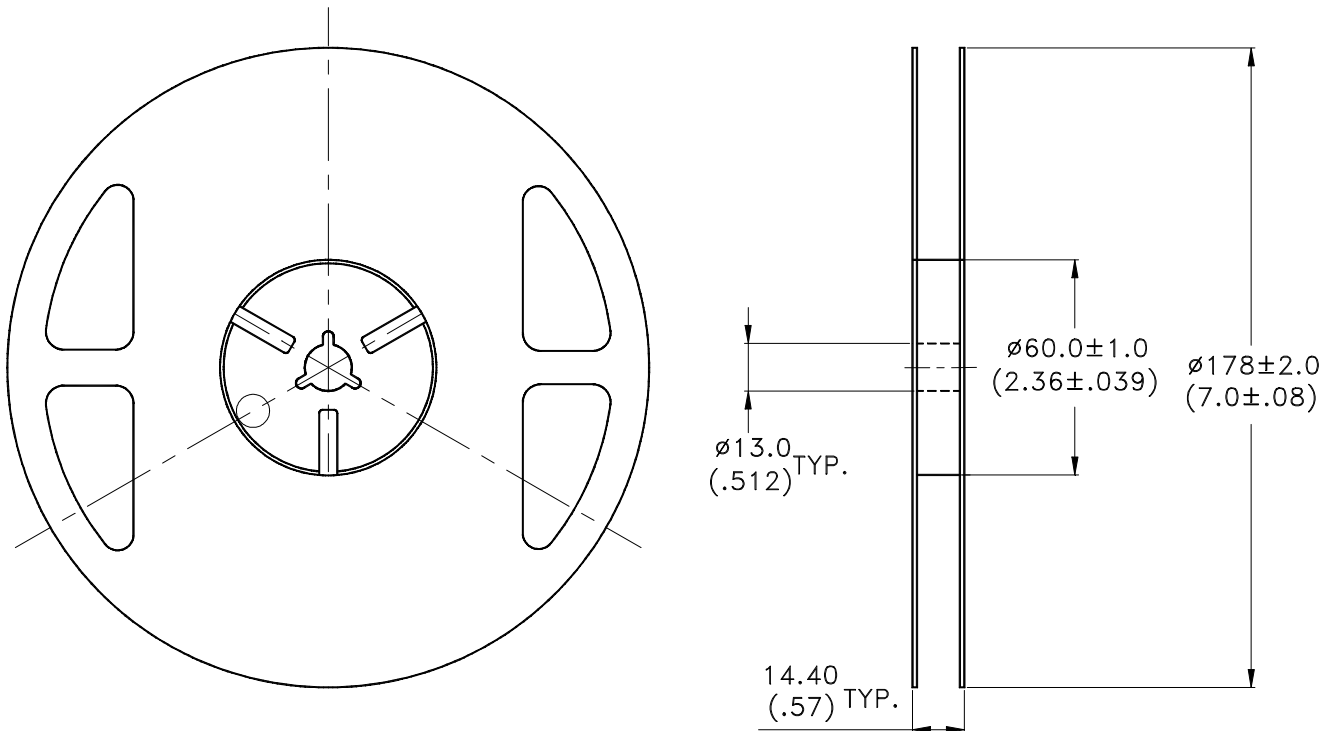
Package Dimensions of Tape



Note:

1. All dimensions are in millimeters (inches).

Package Dimensions of Reel



Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-2000 pieces per reel.
3. Minimum packing quantity is 500 pieces for remainders.
4. The maximum number of consecutive missing lamps is two.
5. In accordance with EIA-481-1-B specifications.

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Lite-on's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

This product is qualified as Moisture sensitive Level 3 per JEDEC J-STD-020 Precaution when handling this moisture sensitive product is important to ensure the reliability of the product.

The package is sealed:

The LEDs should be stored at 30°C or less and 90%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The LEDs should be stored at 30°C or less and 60%RH or less. Moreover, the LEDs are limited to solder process within 168hrs. If the Humidity Indicator shows the pink color in 10% even higher or exceed the storage limiting time since opened, that we recommended to baking LEDs at 60°C at least 48hrs. To seal the remainder LEDs return to package, it's recommended to be with workable desiccants in original package.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

4. Soldering

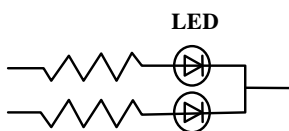
Recommended soldering conditions:

Reflow soldering		Soldering iron	
Pre-heat	120~150°C	Temperature	300°C Max.
Pre-heat time	120 sec. Max.	Soldering time	3 sec. Max.
Soldering Temp. Soldering time	260°C Max. 30 sec. Max.		(two times only)

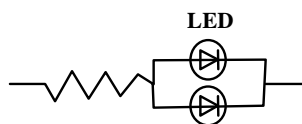
5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

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- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "light up" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

7. Reliability Test

Test Item	Test Condition	Reference Standard	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	Tsld=260℃, 10sec.	JEITA ED-4701 300 301	2 times	0/30
Solderability (Reflow Soldering)	Tsld=245±5℃, 3sec. (Lead Free Solder)	JEITA ED-4701 300 303	1 time Over 95%	0/30
Thermal Shock	-30℃ ~ 85℃ 30min.. 30min.	JEITA ED-4701 300 307	200 cycles	0/30
Temperature Cycle	-40℃ ~ 25℃ ~ 100℃ ~ 25℃ 30min. 5min. 30min. 5min.	JEITA ED-4701 100 105	200 cycles	0/30
High Temperature Storage	Ta=100℃	JEITA ED-4701 200 201	1000 hrs.	0/30
Temperature Humidity Storage	Ta=60℃, RH=90%	JEITA ED-4701 100 103	1000 hrs.	0/30
Low Temperature Storage	Ta=-40℃	JEITA ED-4701 200 202	1000 hrs.	0/30
Steady State Operating Life Condition	Ta=25℃, IF=60mA (20mA per Die)		1000 hrs.	0/30
Steady State Operating Life of High Temperature	Ta=60℃, IF=60mA (20mA per Die)		1000 hrs.	0/30
Steady State Operating Life of High Temperature	Ta=85℃, IF=15mA(5mA per Die)		1000 hrs.	0/30
Steady State Operating Life of High Humidity Heat	60℃, RH=90%, IF=60mA (20mA per Die)		500 hrs.	0/30
Steady State Operating Life of low Temperature	Ta=-40℃, IF=60mA (20mA per Die)		1000 hrs.	0/30

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

9. Estimated Life time

Item	Test Condition	Min.	Typ	Max	Unit
MTTF [1]	Ta=60°C, IF=60mA(20mA/die), Tj ≤ 75°C [2]	30000	-	-	hrs

[1] Mean Time To Failure that estimated time to 50% degradation of initial luminous intensity.

[2] $T_j = T_s + R_{th}(J-S) * W$

Tj = Temperature of LED junction : °C

Ts = Temperature of package solder: °C

Rth(J-S) = The thermal resistance from Junction to Solder

W = Inputting Power (If * Vf) : W

Test board dimension: 25x25x1 mm³ (L x W x H) ; Material: FR4



10. Suggested Checking List

Training and Certification

1. Everyone working in a static-safe area is ESD-certified?
2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

1. Static-safe workstation or work-areas have ESD signs?
2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
3. All ionizer activated, positioned towards the units?
4. Each work surface mats grounding is good?

Personnel Grounding

1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
2. If conductive footwear used, conductive flooring also present where operator stand or walk?
3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
5. All wrist strap or heel strap checkers calibration up to date?

Note: *50V for Blue LED.

Device Handling

1. Every ESDS items identified by EIA-471 labels on item or packaging?
2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

1. Audit result reported to entity ESD control coordinator?
2. Corrective action from previous audits completed?
3. Are audit records complete and on file?